

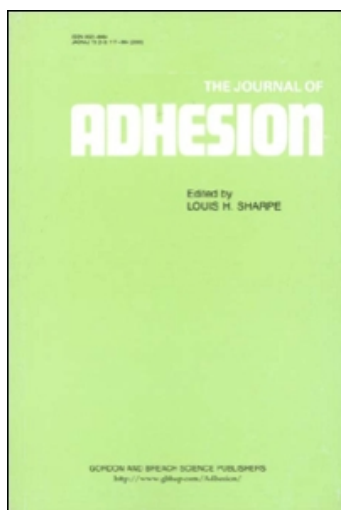
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### **Foreword**

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## Foreword

These proceedings report on papers presented at the Second Annual International Symposium on Adhesion and Adhesives for Structural Materials held in Pullman, Washington, on September 28-30, 1982.

This is the second of what is hoped to be a continuing series directed at expanding the information base of bonding structural materials. A very important secondary goal of this symposium series is to provide the opportunity for interaction between researchers of different disciplines to meet and discuss mutual problems; structural materials include everything from metals to wood and polymers, to ceramics and the various combinations of these materials.

The papers which were accepted reflect the international flavor of the meeting, with papers from New Zealand, Canada, and the U.S. The reader's perusal of the material will reveal papers on adhesive chemistry, instrumentation, and substrate/adhesive interaction.

These excellent papers reflect some of the best current thinking on the subject and it is a delight, as the Symposium Chairman, to be able to pass these on as representative of this young symposium series. With but a little luck and hard work, I hope we can continue to bring a quality symposium proceedings to the pages of THE JOURNAL OF ADHESION.

William E. Johns  
Symposium Chairman  
and Ad Hoc Editor